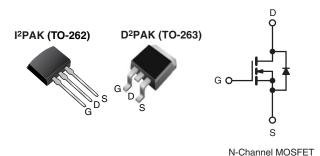


Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	60				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.028				
Q _g (Max.) (nC)	67				
Q _{gs} (nC)	18				
Q _{gd} (nC)	25				
Configuration	Single				



FEATURES

- Halogen-free According to IEC 61249-2-21 **Definition**
- Advanced Process Technology
- Surface Mount (IRFZ44S, SiHFZ44S)
- Low-Profile Through-Hole (IRFZ44L, SiHFZ44L)
- 175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC







DESCRIPTION

Third generation Power MOSFETs from Vishay utilize advanced processing techniques to achieve extermely low on resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that power MOSFETs are well known for, provides the designer with an extermely efficient reliabel deviece for use in a wide variety of applications.

The D²PAK is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and lowest possible on-resistance in any existing surface mount package. The D2PAK is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

The through-hole version (IRFZ44L, SiHFZ44L) is available for low profile applications.

ORDERING INFORMATION					
Package	D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)	I ² PAK (TO-262)	
Lead (Pb)-free and Halogen-free	SiHFZ44S-GE3	SiHFZ44STRR-GE3a	SiHFZ44STRL-GE3a	-	
Lead (Pb)-free	IRFZ44SPbF	IRFZ44STRRPbFa	IRFZ44STRLPbFa	IRFZ44LPbF	
Lead (Fb)-life	SiHFZ44S-E3	SiHFZ44STR-E3a	SiHFZ44STL-E3a	SiHFZ44L-E3	

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltagef			V _{DS}	60	V	
Gate-Source Voltagef			V_{GS}	± 20	7 v	
Continuous Drain Currente	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	I-	50		
Continuous Drain Current	V_{GS} at 10 V $T_C = 100 ^{\circ}C$		I _D	36	Α	
Pulsed Drain Current ^{a, e}			I _{DM}	200		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	100	mJ	
Maximum Power Discipation	T _A =	25 °C		3.7	W	
Maximum Power Dissipation T _C		25 °C	P_{D}	150] vv	
Peak Diode Recovery dV/dt ^{c, f}			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature ^d)	for	10 s	_	300	7	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD}=25$ V; starting $T_J=25$ °C, L = 44 µH, $R_g=25$ Ω , $I_{AS}=51$ Å (see fig. 12). c. $I_{SD}\le51$ Å, $dI/dt\le250$ Å/µs, $V_{DD}\le V_{DS}$, $T_J\le175$ °C.
- 1.6 mm from case.
- Calculated continuous current based on maximum allowable junction temperature.
- f. Uses IRFZ44, SiHFZ44 data and test conditions.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFZ44S, IRFZ44L, SiHFZ44S, SiHFZ44L

Vishay Siliconix



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient (PCB Mounted, steady-state) ^a	R _{thJA}	-	40	°C/W		
Maximum Junction-to-Case	R _{thJC}	-	1.0			

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static					l		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$, $I_D = 250 \mu A$		60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.06	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zoro Cata Valtaga Drain Current	1	V _{DS} :	= 60 V, V _{GS} = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 48 V,	V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 31 A ^b	-	-	0.028	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	= 25 V, I _D = 31 A ^b	15	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	1900	-	
Output Capacitance	C _{oss}]	$V_{DS} = 25 \text{ V},$		920	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.0	MHz, see fig. 5 d	-	170	-	,
Total Gate Charge	Qg		$V_{GS} = 10 \text{ V}$ $I_D = 51 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13b		-	67	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V			-	18	
Gate-Drain Charge	Q_{gd}	1			-	25	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 30 V, I _D = 51 A,		-	14	-	
Rise Time	t _r			-	110	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = S$.1 Ω , R _D = 0,55 Ω , see fig. 10 ^b	-	45	-	ns
Fall Time	t _f			-	92	-	
Internal Source Inductance	L _S	Between lead	, and center of die contact	-	7.5	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol	-	-	50 ^d	- A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		_	_	200	
Body Diode Voltage	V_{SD}	T _J = 25 °C	S, I _S = 51 A, V _{GS} = 0 V ^b	-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T - 25 °C 1	- 51 A dl/dt - 100 A/:-ab d	-	120	180	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 51 \text{A, dl/dt} = 100 \text{A/}\mu\text{s}^{\text{b, d}}$		-	530	800	nC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	y L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.
- c. Uses IRFZ44, SiHFZ44 data and test conditions.
- d. Calculated continuous current based on maximum allowable junction temperature.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

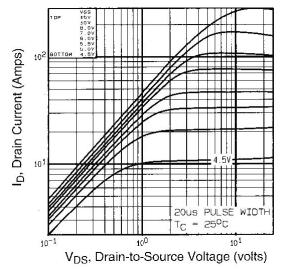


Fig. 1 - Typical Output Characteristics

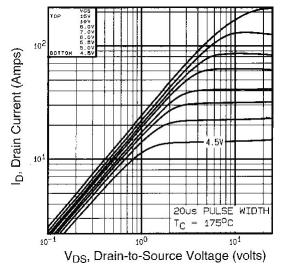


Fig. 2 - Typical Output Characteristics

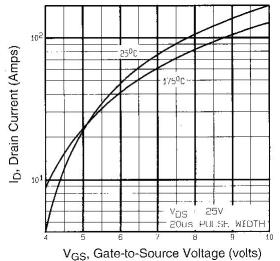


Fig. 3 - Typical Transfer Characteristics

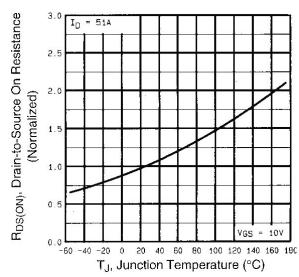


Fig. 4 - Normalized On-Resistance vs. Temperature



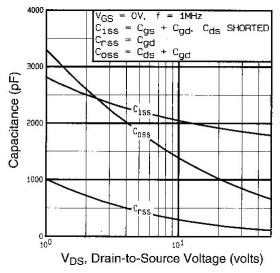


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

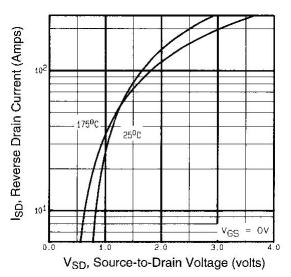


Fig. 7 - Typical Source-Drain Diode Forward Voltage

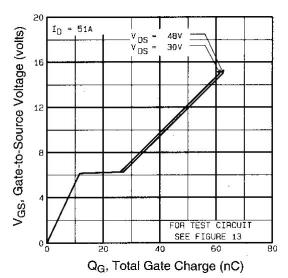


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

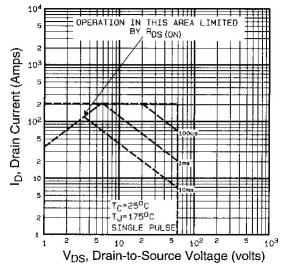


Fig. 8 - Maximum Safe Operating Area

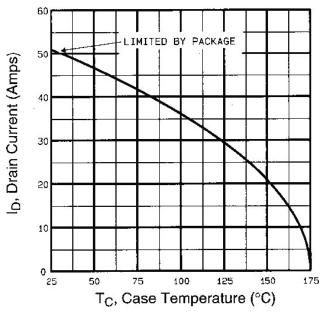


Fig. 9 - Maximum Drain Current vs. Case Temperature

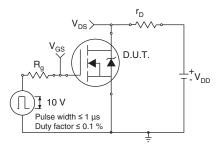


Fig. 10a - Switching Time Test Circuit

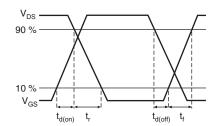


Fig. 10b - Switching Time Waveforms

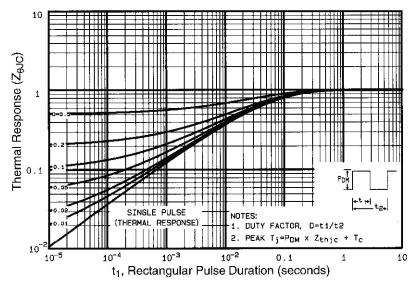


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



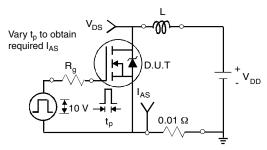


Fig. 12a - Unclamped Inductive Test Circuit

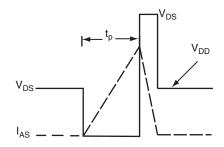


Fig. 12b - Unclamped Inductive Waveforms

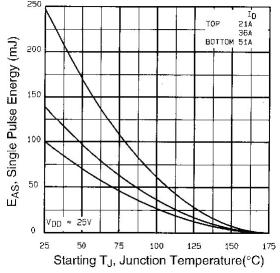


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

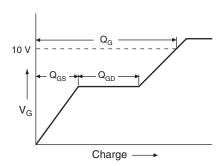


Fig. 13a - Basic Gate Charge Waveform

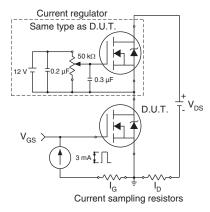
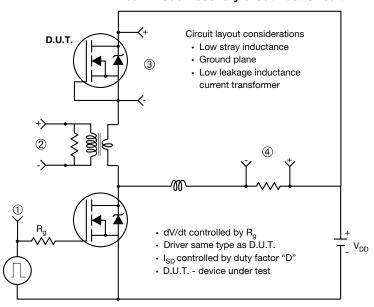


Fig. 13b - Gate Charge Test Circuit

Peak Diode Recovery dV/dt Test Circuit



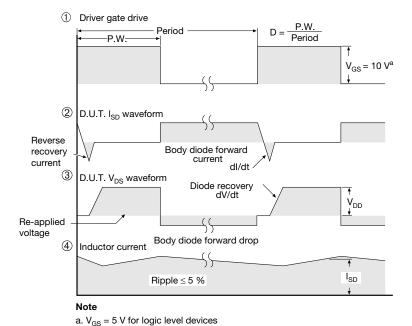


Fig. 14 - For N-Channel

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TO-263AB (HIGH VOLTAGE)







	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	ı
е	2.54 BSC		0.100 BSC	
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	ı	0.066
L2	-	1.78	-	0.070
L3	0.25 BSC		0.010	BSC
L4	4.78	5.28	0.188	0.208

ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

Notes

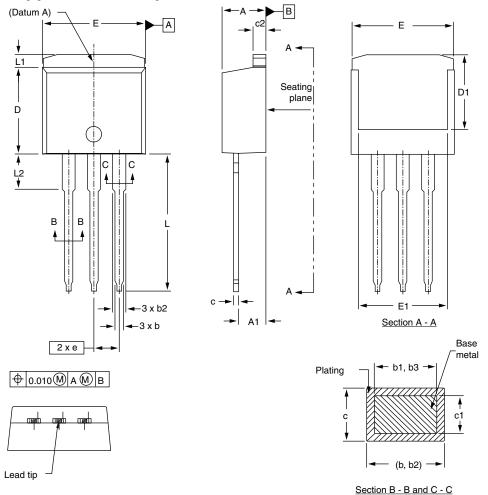
- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 www.vishay.com Revision: 15-Sep-08





I²PAK (TO-262) (HIGH VOLTAGE)



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	2.03	3.02	0.080	0.119
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D	8.38	9.65	0.330	0.380
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	-
е	2.54	BSC	0.100 BSC	
L	13.46	14.10	0.530	0.555
L1	-	1.65	-	0.065
L2	3.56	3.71	0.140	0.146

Scale: None

ECN: S-82442-Rev. A, 27-Oct-08 DWG: 5977

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outmost extremes of the plastic body.
- 3. Thermal pad contour optional within dimension E, L1, D1, and E1.
- 4. Dimension b1 and c1 apply to base metal only.

Document Number: 91367 Revision: 27-Oct-08



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